

**EXPEDITED PROCEDURE – EXAMINING GROUP 1725**

**S/N 10/823,314**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Neo C. Peng et al.

Examiner: Samuel M Heinrich

Serial No.: 10/823,314

Group Art Unit: 1725

Filed: April 13, 2004

Docket No.: 303.772US2

Title: WAFER DICING DEVICE AND METHOD

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**AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Final Office Action mailed July 13, 2006, please amend the application as follows: